# UNIVERSAL



**Dual-Cured Adhesive** 



BISCO BISCO
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Dual-Cured Adhesive





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PARTB



## UNIVERSAL PRIMER

Universal Primer is a dual-cured adhesive designed to be used without having to cure the adhesive layer under indirect restorations. With chemistry based on BISCO's All-Bond Universal® technology, Universal Primer can be used with any etching technique (self-etch, selective-etch, or total-etch) and is compatible with light-cured, dual-cured, and self-cured resin cements, composites, and core materials for direct and indirect bonding procedures.

## **FEATURES & BENEFITS**



#### **Dual Cured**

Adhesive for those who wish not to light cure.



#### Low Film Thickness

Less than 5µm allows adhesive to readily flow into etched surfaces.



#### Versatile

Can be used with total-, self, and selective-etch techniques.





#### Contains MDP Monomer

For enhanced bonding.



#### Easy to Use

Clinical evaluation confirms the ease-of-use, with virtually no post-operative sensitivity.

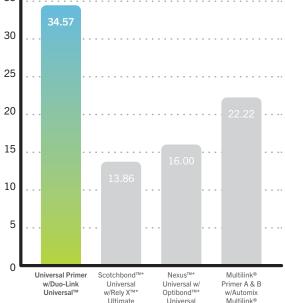


#### Compatible

With light-cured, dual-cured, and self-cured resin cements, composites, and core materials for direct and indirect bonding procedures.



Shear Bond Strength to



Both the adhesive and the cement were self-cured, per manufacturer instruction. \*Trademarks are property of their respective owner

#### Shear Bond Strength to Various Substrates (Duo-Link Universal)†

SUBSTRATE	UNIVERSAL PRIMER
Cut Enamel (SE/TE)	25.14/31.53
Dentin (SE/TE)	26.78 / 32.47
Lithium Disilicate (silane treated)	35.02
Zirconia	31.14
Stainless Steel	35.59
Titanium	28.39
Gold	19.71
Composite	28.73

 $^{\dagger} Data \ on \ file, \ BISCO, \ Inc.$  Both Universal Primer & Duo-Link Universal were tested in self-cure mode using the Ultradent jig method.

### **DID YOU KNOW?**

MDP is the functional, adhesion promoting monomer contained in Universal Primer's formulation. Proven to provide exceptional stability in a chemical bond over time, MDP also enables Universal Primer to bond to zirconia and other metal substrates, as well as composites and resin cements on the market. Due to MDP, Universal Primer does not require etching with phosphoric acid to bond. Universal Primer can be used successfully in self-etch, total-etch, and selective-etch modes.

Exclusively distributed by Curion

curion.ca | EN: 1.800.667.8811 FR: 1.800.211.1200

